L Name ban	Hits	Search Text	DB	Time stamp
Number 1	2896924	power smae shut\$3 same off and wafer	USPAT;	2004/09/29
•	2000024	same (edge or flat) same (align or	US-PGPUB;	13:09
		alignment or adjust or adjustment or	EPO; JPO;	10.00
		orientation or position) same (angle or	DERWENT;	
		angular)	IBM_TDB	`
2	52	power same shut\$3 same off and wafer	USPAT;	2004/09/29
_	32	same (edge or flat) same (align or	US-PGPUB;	13:09
٠,		alignment or adjust or adjustment or	EPO; JPO;	13:09
		orientation or position) same (angle or	DERWENT;	
		, ,		
_	999	angular)	IBM_TDB	2004/00/00
4	882	wafer same (flat or edge) same shift	USPAT;	2004/09/29
			US-PGPUB;	13:20
			EPO; JPO;	:
			DERWENT;	
			IBM_TDB	
3	1	wafer adj (flat or edge) adj shift	USPAT;	2004/09/29
			US-PGPUB;	13:13
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
5	1962	((702/150) or (414/935,936)).CCLS.	USPAT;	2004/09/29
			US-PGPUB;	13:14
			EPO; JPO;	
			DERWENT;	
•			IBM_TDB	
7	19	(wafer same (flat or edge) same shift) and	USPAT;	2004/09/29
		(((702/150) or (414/935,936)).CCLS.)	US-PGPUB;	13:20
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
8	5	("3174392" "4457664" "4833790"	USPAT	2004/09/29
		"5085558" "5308222").PN.		13:18
9 .	3	(wafer same (flat or edge) same shift) and	USPAT;	2004/09/29
		(((702/150) or (414/935,936)).CCLS.) and	US-PGPUB;	13:20
		power	EPO; JPO;	,
			DERWENT;	
			IBM_TDB	
10	3	(wafer same (flat or edge) same shift) and	USPAT;	2004/09/29
		(((702/150) or (414/935,936)).CCLS.) and	US-PGPUB;	13:20
		1	EPO; JPO;	13.20
		power	DERWENT;	}
			1	
44		wefor some (flot or odne) some skift or	IBM_TDB	2004/00/00
11	0	wafer same (flat or edge) same shift same	USPAT;	2004/09/29
		(angle or position or orientation or angular	US-PGPUB;	13:25
		or rotate or rotation) and power same	EPO; JPO;	
		shut\$3 same off	DERWENT;	·
	1		IBM_TDB	

12	0	wafer same (flat or edge) same (measur\$5	USPAT;	2004/09/29
		or sens\$3 or detect\$3 or analy\$4 or test\$3	US-PGPUB;	13:23
		or identif\$5 or determin\$3 or monitor\$3 or	EPO; JPO;	
		inspect\$3 or diagnos\$3) same angular same	DERWENT;	
	1	displacement and power same shut\$3 same off	IBM_TDB	
13	29	wafer same (flat or edge) same (measur\$5	USPAT;	2004/09/29
		or sens\$3 or detect\$3 or analy\$4 or test\$3	US-PGPUB;	13:25
		or identif\$5 or determin\$3 or monitor\$3 or	EPO; JPO;	
ľ		inspect\$3 or diagnos\$3) same angular same	DERWENT;	
		displacement	IBM_TDB	:
14	527	wafer same power same (shut\$3 or turn)	USPAT;	2004/09/29
		same off	US-PGPUB;	13:25
			EPO; JPO;	
		,	DERWENT;	
			IBM_TDB	
15	132	wafer same power same (shut\$3 or turn)	USPAT;	2004/09/29
		same off same (angle or angular or position	US-PGPUB;	13:27
		or orientation)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
16	3	wafer same power same (shut\$3 or turn)	USPAT;	2004/09/29
		same off same (angle or angular or position	US-PGPUB;	13:26
		or orientation) and relay and solenoid	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
17	78	wafer same power same (shut\$3 or turn)	USPAT;	2004/09/29
		same off same (angle or angular or position	US-PGPUB;	13:32
		or orientation) and wafer same (edge or	EPO; JPO;	
		flat)	DERWENT;	
40	0.4	(ab.,462 a., 4)	IBM_TDB	2004/00/20
18	81	wafer same power same (shut\$3 or turn)	USPAT;	2004/09/29 13:30
	-	same (off or down) same (angle or angular or position or orientation) and wafer same	US-PGPUB; EPO; JPO;	13:30
		,	DERWENT;	
		(edge or flat)	IBM_TDB	
19	3	(wafer same power same (shut\$3 or turn)	USPAT;	2004/09/29
19	3	same (off or down) same (angle or angular	US-PGPUB;	13:30
		or position or orientation) and wafer same	EPO; JPO;	13.30
		(edge or flat)) not (wafer same power same	DERWENT;	
		(shut\$3 or turn) same off same (angle or	IBM_TDB	
		angular or position or orientation) and	.5	
		wafer same (edge or flat))		
20	406	power same (shut\$3 or turn) same (down or	USPAT;	2004/09/29
	-144	off) and wafer same (edge or flat) and	US-PGPUB;	13:34
		(measur\$5 or sens\$3 or detect\$3 or analy\$4	EPO; JPO;	. =
		or test\$3 or identif\$5 or determin\$3 or	DERWENT;	
		monitor\$3 or inspect\$3 or diagnos\$3) same	IBM_TDB	
		(orientation or angle or angular)	_	

21	45	power same (shut\$3 or turn) same (down or	USPAT;	2004/09/29
		off) and wafer same (edge or flat) same	US-PGPUB;	13:34
		(measur\$5 or sens\$3 or detect\$3 or analy\$4	EPO; JPO;	
		or test\$3 or identif\$5 or determin\$3 or	DERWENT;	
		monitor\$3 or inspect\$3 or diagnos\$3) same	IBM_TDB	
		(orientation or angle or angular)		
22	7	(US-4880348-\$ or US-4449885-\$ or	USPAT	2004/09/29
		US-4498833-\$ or US-4836733-\$ or		13:41
		US-6160338-\$ or US-5452521-\$ or		
		US-5483138-\$).did.	:	
23	4	((US-4880348-\$ or US-4449885-\$ or	USPAT	2004/09/29
		US-4498833-\$ or US-4836733-\$ or		13:41
		US-6160338-\$ or US-5452521-\$ or		
		US-5483138-\$).did.) and power		
24	21	wafer and (edge or flat) and relay and	USPAT	2004/09/29
		solenoid and door and (orientation of angle		14:26
		or angular)		
25	75	wafer same (position or orientation) same	USPAT	2004/09/29
		(angle or angular) and power same (shut\$3)		13:51
		same (off or down)		1010 1
26	48	("4405435" "4498416" "4592306"	USPAT	2004/09/29
	40	"4607593" "4664062" "4681773"	JOIAI	13:59
		"4709655" "4715921" "4717461"		10.00
		"4722298" "4733631" "4739787"		
		"4820106" "4825808" "4852516"		
		"4857160" "4886592" "4917556"		
		"4951601" "5000113" "5067218"		
		"5076205" "5083364" "5088444"		
		"5186718" "5199483" "5259881"		
		"5292393" "5352248" "5380682"		
		"5516732" "5520002" "5582866"		
		"5611655" "5620578" "5740034"		
		"5758680" "5769952" "5784238"		
		"5785796" "5855681" "5873942"		
		5765796 5655661 5675942 "5900105" "5930456" "5944857"		
		· · · · · · · · · · · · · · · · · · ·		
27	2	"6017395" "6083321" "6120606").PN.	HEDAT.	2004/09/29
21	2	("6312525").PN.	USPAT;	
			US-PGPUB;	14:05
			EPO; JPO;	
			DERWENT;	
	FOF	(manager of a second of the se	IBM_TDB	2004/00/20
28	585	(measur\$5 or sens\$3 or detect\$3 or analy\$4	USPAT;	2004/09/29
		or test\$3 or identif\$5 or determin\$3 or	US-PGPUB;	14:05
:		monitor\$3 or inspect\$3 or diagnos\$3) same	EPO; JPO;	
		wafer same (edge or flat) same (offset or	DERWENT;	
		shift)	IBM_TDB	ı

29	130	(measur\$5 or sens\$3 or detect\$3 or analy\$4	USPAT;	2004/09/29
		or test\$3 or identif\$5 or determin\$3 or	US-PGPUB;	14:06
		monitor\$3 or inspect\$3 or diagnos\$3) same	EPO; JPO;	
		wafer same (edge or flat) same (offset or	DERWENT;	
		shift) and (power or shut\$3 or turn) same	IBM_TDB	
		(off or down)		
30	83	(measur\$5 or sens\$3 or detect\$3 or analy\$4	USPAT;	2004/09/29
		or test\$3 or identif\$5 or determin\$3 or	US-PGPUB;	14:07
		monitor\$3 or inspect\$3 or diagnos\$3) same	EPO; JPO;	
		wafer same (edge or flat) same (offset or	DERWENT;	
		shift) and (power or shut\$3 or turn) near4	IBM_TDB	
		(off or down)	-	
31	105	(measur\$5 or sens\$3 or detect\$3 or analy\$4	USPAT;	2004/09/29
		or test\$3 or identif\$5 or determin\$3 or	US-PGPUB;	14:15
		monitor\$3 or inspect\$3 or diagnos\$3) same	EPO; JPO;	
		wafer same (edge or flat) same (offset or	DERWENT;	
		shift) and (power or shut\$3 or turn\$3) near4	IBM_TDB	
		(off or down)		·
32	2	("5,563,798").PN.	USPAT;	2004/09/29
			US-PGPUB;	14:15
			EPO; JPO;	
			DERWENT;	
		,	IBM_TDB	
38	1560	wafer same (edge or flat or orientation or	USPAT	2004/09/29
		postition) and door		14:27
39	836	wafer same (edge or flat or orientation or	USPAT	2004/09/29
	_	postition) and door and power		14:27
37	4	wafer same (edge or flat or orientation or	USPAT	2004/09/29
		postition) and relay same solenoid same door		14:27
-	708	(702/150).CCLS.	USPAT;	2004/09/28
			US-PGPUB;	17:59
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	131	wafer same flat same shift and (angle or	USPAT;	2004/09/28
		angular)	US-PGPUB;	17:36
		·	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	266	wafer same flat same shift	USPAT;	2004/09/28
			US-PGPUB;	17:36
			EPO; JPO;	
			DERWENT;	
	405	(man-sumbE am - map) 1 - 4	IBM_TDB	2004/00/00
•	105	(measur\$5 or sens\$3 or detect\$3 or analy\$4	USPAT;	2004/09/28
		or test\$3 or identif\$5 or determin\$3 or	US-PGPUB;	17:36
		monitor\$3 or inspect\$3 or diagnos\$3) same wafer same flat same shift	EPO; JPO;	
		water same flat same SNIT	DERWENT;	
	1	!	IBM_TDB	i

-	5	wafer same flat same shift and solenoid	USPAT;	2004/09/28
			US-PGPUB;	17:38
		•	EPO; JPO;	
			DERWENT;	
		•	IBM_TDB	
-	0	wafer adj flat adj shift	USPAT;	2004/09/29
		•	US-PGPUB;	13:13
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	2667	wafer adj flat	USPAT;	2004/09/28
			US-PGPUB;	17:46
*			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	425	wafer adj flat same (orientation or position)	USPAT;	2004/09/28
-	423	maior auj nat same (orientation or position)	US-PGPUB;	17:39
			EPO; JPO;	17.00
			DERWENT;	
			IBM_TDB	
	_		_	2004/00/29
•	5	wafer adj flat same (orientation or position)	USPAT;	2004/09/28
		and relay and solenoid	US-PGPUB;	17:39
		·	EPO; JPO;	
			DERWENT;	
	_		IBM_TDB	0004/00/00
-	5	wafer adj flat same (orientation or position)	USPAT;	2004/09/28
		and relay and solenoid and (angle or	US-PGPUB;	17:42
		angular)	EPO; JPO;	·
			DERWENT;	
			IBM_TDB	
•	69	wafer adj flat same (orientation or position)	USPAT;	2004/09/28
		same (angle or angular)	US-PGPUB;	17:44
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	0	jean-hua-yuen.in.	USPAT;	2004/09/28
			US-PGPUB;	17:44
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	0	yuen-jean-hua.in.	USPAT;	2004/09/28
			US-PGPUB;	17:45
•			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	0	po-ming-chen.in.	USPAT;	2004/09/28
	1		US-PGPUB;	17:44
			EPO; JPO;	
		,	DERWENT;	
		,	IBM_TDB	

US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; IMM_TDB US-PGPUB; E		2	chen-po-ming.in.	USPAT;	2004/09/28
- 0 chiang-ming-ji.in. EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPU		_		1	
- 0 chiang-ming-ji.in. - 0 yuen-jean.in. - 10 yuen-jean.i				,	
- 0 chiang-ming-ji.in. - 1 0 chiang-ming-ji.in. - 2 0 chiang-ming-ji.in. - 3 0 chiang-ming-ji.in. - 4 0 chiang-ming-ji.in. - 5 0 chiang-ming-ji.in. - 6 0 chiang-ming-ji.in. - 7 0 chiang-ming-ji.in. - 8 chiang-ming-ji.in. - 9 chiang-ming-ji.in. - 9 chiang-ming-ji.in. - 1 0 yuen-jean.in. - 1 0 yang-ji-shen.in. - 2 0 yang-ji-shen.in. - 3 0 yang-ji-shen.in. - 4 0 yang-ji-shen.in. - 5 0 yang-ji-shen.in. - 6 0 yang-ji-shen.in. - 7 0 yang-ji-shen.in. - 8 0 yang-ji-shen.in. - 8 0 yang-ji-shen.in. - 8 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 2 0 yang-ji-shen.in. - 3 0 yang-ji-shen.in. - 4 0 yang-ji-shen.in. - 5 0 yang-ji-shen.in. - 6 0 yang-ji-shen.in. - 7 0 yang-ji-shen.in. - 8 0 yang-ji-shen.in. - 9 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 2 0 yang-ji-shen.in. - 3 0 yang-ji-shen.in. - 4 0 yang-ji-shen.in. - 5 0 yang-ji-shen.in. - 6 0 yang-ji-shen.in. - 7 0 yang-ji-shen.in. - 8 0 yang-ji-shen.in. - 9 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 2 0 yang-ji-shen.in. - 3 0 yang-ji-shen.in. - 4 0 yang-ji-shen.in. - 5 0 yang-ji-shen.in. - 6 0 yang-ji-shen.in. - 7 0 yang-ji-shen.in. - 8 0 yang-ji-shen.in. - 9 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 2 0 yang-ji-shen.in. - 3 0 yang-ji-shen.in. - 4 0 yang-ji-shen.in. - 5 0 yang-ji-shen.in. - 6 0 yang-ji-shen.in. - 7 0 yang-ji-shen.in. - 8 0 yang-ji-shen.in. - 9 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 2 0 yang-ji-shen.in. - 3 0 yang-ji-shen.in. - 4 0 yang-ji-shen.in. - 5 0 yang-ji-shen.in. - 6 0 yang-ji-shen.in. - 7 0 yang-ji-shen.in. - 9 0 yang-ji-shen.in. - 9 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 1 0 yang-ji-shen.in. - 2 0 yang-ji-shen.in. - 3 0 yang-ji-shen.in. - 6 0 yang-ji-shen.in. - 7 0 yang-ji-shen.in. - 9 0 yang-ji-shen.in. - 9 0 yang-ji-shen.in. - 9 0 yang-ji-shen.in. - 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1				1	
- 0 chiang-ming-ji.in. USPAT; US-PGPUB; EPQ; JPQ; DERWENT; IBM_TDB USPAT; US-PGPUB; IT:446				,	
- 0 chiang-ming-j.in. US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; US-P	_	0	chiang-ming-li in	_	2004/09/28
- O chiang-ming-j.in. - chiang-ming-j.in. - chiang-ming-j.in. - chiang-ming-j.in. - chiang-ming-j.in. - chiang-ming-j.in. - chiang-ming-in. - chiang-ming.in.	_		- Cinang-ining-jinin	, ·	
- 0 chiang-ming-j.in. - 1 0 chiang-ming-j.in. - 2 0 chiang-ming-j.in. - 3 0 yuen-jean.in. - 4 0 yuen-jean.in. - 5 0 chiang-ming.in. - 6 0 yang-ji-shen.in. - 7 0 yang-ji-shen.in. - 8 1 yang-ji-s\$.in. - 8 1 yang-ji-in. - 8 1 yang-ji-in. - 8 1 yang-ji-in. - 7 0 wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) - 8 1 0 0 yang-yeng yang-				1	17.45
- O chiang-ming-j.in. - O chiang-ming-j.in. - O yuen-jean.in. - O yuen-jean.in. - O yuen-jean.in. - O chiang-ming-j.in. - O yuen-jean.in. - O yang-ji-shen.in. - O yang-ji-shen.in. - O yang-ji-shen.in. - O yang-ji-shen.in. - O wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) - O wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) - O vang-pi-shen.in. - O wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) - O vang-pi-shen.in. - O wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) - O vang-pi-shen.in. - O wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) - O wafer adj flat and (shut\$3 adj (off or power or down)) - O wafer adj flat and (shut\$3 adj (off or power or down)) - O wafer adj flat and (shut\$3 adj (off or power or down)) - O wafer adj flat and (shut\$3 adj (off or power or down)) - O wafer adj flat and (shut\$3 adj (off or power or down))			•		
- 0 chiang-ming-j.in. chiang-ming-j.in. chiang-ming-j.in. USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB				1	•
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT;	_	0	chiang-ming-i in		2004/09/28
EPO; JPO; DERWENT; IBM_TDB USPAT; 2004/09/28 US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; I7:47	_				
DERWENT; IBM_TDB US-PAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; IF:46 EPO; JPO; DERWENT; IBM_TDB US-PGPUB; US-PGPUB; IF:46 EPO; JPO; DERWENT; IBM_TDB US-PGPUB; IF:46 EPO; JPO; DERWENT; IBM_TDB US-PGPUB; IF:47		•		1	171-40
Dear				1 ' '	
- 0 yuen-jean.in. 9 chiang-ming.in. 9 chiang-ming.in. 10 yang-ji-shen.in. 10 yang-ji-shen.in. 10 yang-ji-s\$.in. 10 yang-ji-s\$.in. 10 yang-ji-s\$.in. 10 yang-ji-s\$.in. 11 yang-ji-s\$.in. 12 yang-ji-in. 13 yang-ji-in. 14 yang-ji-in. 15 yang-ji-in. 16 yang-ji-in. 17 yang-ji-in. 18 yang-ji-in. 18 yang-ji-in. 2004/09/28 17:45 2004/09/28 17:46 2004/09/28 17:46 2004/09/28 17:46 2004/09/28 17:46 2004/09/28 17:46 2004/09/28 17:46 2004/09/28 17:46				,	
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; IT:45	_	n	vuen-lean.in.		2004/09/28
EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; IT:46	-		Jaon-Jounnin	1	
- 9 chiang-ming.in. - 9 chiang-ming.in. - 10 yang-ji-shen.in. - 0 yang-ji-shen.in. - 10			,	1	17.75
- Part of the property of the				, ,	
- 9 chiang-ming.in. USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; US-				1	
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; I7:46 - 0 wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) US-PGPUB; 17:47	_		chiana-mina in	· ·	2004/09/28
EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; IF-47	,		cmang-ming.m.	1	
- 0 yang-ji-shen.in. - 0 yang-ji-shen.in. - 0 yang-ji-s\$.in. - 0 yang-ji-s\$.in. - 0 yang-ji-s\$.in. - 0 wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) - 0 DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; I7:46				1	17.43
- 0 yang-ji-shen.in. IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; US-PGPUB				1 '	
- 0 yang-ji-shen.in. USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; IBM_TDB USPAT; US-PGPUB; ISPAT; US-PGPUB; I7:47				1	
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; T7:46 yang-ji-s\$.in. US-PGPUB; 2004/09/28 US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; US-PGPUB; T7:46 yang-ji.in. wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) US-PGPUB; 2004/09/28 US-PGPUB; US-PGPUB; US-PGPUB; US-PGPUB; US-PGPUB; US-PGPUB; US-PGPUB; 17:47	_	0	vang ii chon in		2004/09/28
EPO; JPO; DERWENT; IBM_TDB USPAT; 2004/09/28 US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; USPAT; USPAT; USPAT; USPAT; USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US	-	U	yang-ji-snen.in.	1	
DERWENT; IBM_TDB USPAT; 2004/09/28 US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; IBM_TDB USPAT; US-PGPUB; IBM_TDB USPAT; US-PGPUB; I7:46 - 0 wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) DERWENT; IBM_TDB USPAT; US-PGPUB; 17:46				1	17:40
- 0 yang-ji-s\$.in. IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; IT:47					
- 0 yang-ji-s\$.in. USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; US-PGPUB; I7:47		:		I -	
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; US-PGPUB; US-PGPUB; T7:46 yang-ji.in. yang-ji.in. wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; 2004/09/28 US-PGPUB; 17:46			vangii.c¢ in		2004/09/28
EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; USPAT; US-PGPUB; USPAT; US-PGPUB; US-PGPU	-		yang-ji-sw.iii.		
DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; USPAT; USPAT; USPAT; USPAT; USPAT; USPAT; USPAT; USPAT; USPGPUB; USPAT; USPGPUB;				1	17.40
- 8 yang-ji.in. IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; O wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) US-PGPUB; US-PGPUB; US-PGPUB; US-PGPUB; US-PGPUB;					
- 8 yang-ji.in. USPAT; 2004/09/28 17:46 US-PGPUB; EPO; JPO; DERWENT; IBM_TDB Wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) USPAT; 2004/09/28 17:47					
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) US-PGPUB; 17:46 US-PGPUB; 2004/09/28 US-PGPUB; 17:47	_	R	vang-li.in.		2004/09/28
EPO; JPO; DERWENT; IBM_TDB wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) US-PGPUB; 17:47				,	
DERWENT; IBM_TDB wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) US-PGPUB; 17:47	-			1	
- 0 wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) US-PGPUB; 17:47			·	1 ' '	
- Wafer adj flat and (shut\$3 adj (off or power or down)) and sensor and (angle or angular) US-PGPUB; 17:47				1	
or down)) and sensor and (angle or angular) US-PGPUB; 17:47	_	a	wafer adi flat and (shut\$3 adi (off or nower		2004/09/28
			, , , , , , , , , , , , , , , , , , , ,	· ·	
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DERWENT;				1 '	
IBM_TDB				1	
- 76 wafer adj flat and (shut\$3 adj (off or power USPAT; 2004/09/28	_	76	wafer adi flat and (shut\$3 adi (off or nower	1	2004/09/28
or down)) and sensor and (angle or angular) US-PGPUB; 17:53			· · · · · · · · · · · · · · · · · · ·	1	
EPO; JPO;]			1	
DERWENT;					
IBM_TDB				1	

	T -		HCDAT.	2004/00/20
-	7	wafer adj flat adj alignment	USPAT;	2004/09/28
			US-PGPUB;	17:54
			EPO; JPO;	
			DERWENT;	
	4000	((700/470)	IBM_TDB	0004/00/00
-	1962	((702/150) or (414/935,936)).CCLS.	USPAT;	2004/09/29
			US-PGPUB;	13:14
· ·			EPO; JPO;	
1			DERWENT;	
			IBM_TDB	
-	0	(((702/150) or (414/935,936)).CCLS.) and	USPAT;	2004/09/28
		relay and solenoid	US-PGPUB;	17:59
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	16	(((702/150) or (414/935,936)).CCLS.) and	USPAT;	2004/09/28
		wafer and flat and (angle of angular) and	US-PGPUB;	18:00
		(position or orientation) and (power same	EPO; JPO;	
		off)	DERWENT;	
		-	IBM_TDB	
-	15	(((702/150) or (414/935,936)).CCLS.) and	USPAT;	2004/09/28
		wafer and flat and (angle or angular) and	US-PGPUB;	18:10
		(position or orientation) and (power same	EPO; JPO;	
		off)	DERWENT;	
		011)	IBM_TDB	
_	1	(((702/150) or (414/935,936)).CCLS.) and	USPAT;	2004/09/28
-	•	wafer and flat and (angle or angular) same	US-PGPUB;	18:10
		displacement and (position or orientation)	EPO; JPO;	10.10
		and (power same off)	DERWENT;	•
		and (power same on)	IBM_TDB	
	26	(((702/150) or (414/935,936)).CCLS.) and	USPAT;	2004/09/28
-	20	, , , , , , , , , , , , , , , , , , , ,	US-PGPUB;	18:10
		wafer and flat and (angle or angular) same	EPO; JPO;	10.10
·		displacement		
			DERWENT;	
		((/702/4E0) (44.4/02E 020)) 001.0 \	IBM_TDB	2004/00/29
•	6	(((702/150) or (414/935,936)).CCLS.) and	USPAT;	2004/09/28
		wafer same flat same (angle or angular)	US-PGPUB;	18:10
		same displacement	EPO; JPO;	
			DERWENT;	
			IBM_TDB	0004/00/00
	1	(((702/150) or (414/935,936)).CCLS.) and	USPAT;	2004/09/28
		wafer and flat and (angle or angular) same	US-PGPUB;	18:11
	ľ	displacement and (power same off)	EPO; JPO;	
			DERWENT;	
		,	IBM_TDB	
-	2	4498833.pn.	USPAT;	2004/09/29
			US-PGPUB;	13:07
			EPO; JPO;	
		·	DERWENT;	
·			IBM_TDB	
-	21	4498833.URPN.	USPAT	2004/09/28
	.l		<u> </u>	18:21